Absolute Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Supply Voltage	V_{CC}	-50	V
Input Voltage	V_{IN}	+6 to -40	V
Output Current	I_O	-70	mA
Output (Collector) Current	$I_{C(MAX)}$	-100	mA

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P_D	250	mW
Power Derating above +25°C	P_{der}	2	mW/°C
Thermal Resistance, Junction to Ambient Air (Note 5) (Equivalent to one heated junction of PNP)	$R_{\theta JA}$	500	°C/W
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to +150	°C

Electrical Characteristics: Discrete PNP Transistor (Q1) (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Off Characteristics (Note 6)						
Collector-Base Breakdown Voltage	BV_{CBO}	-50	—	—	V	I_C = -100µA, I_E = 0
Collector-Emitter Breakdown Voltage	BV_{CEO}	-50	—	—	V	I_C = -10.0mA, I_B = 0
Collector-Base Cut Off Current	I_{CBO}	—	—	-0.1	µA	V_{CB} = -50V, I_E = 0
Collector-Emitter Cut Off Current, $I_{O(off)}$	I_{CES}	—	—	-0.1	µA	V_{CB} = -50V, I_B = 0
Emitter-Base Cut Off Current	I_{EBO}	—	—	-0.2	mA	V_{EB} = 5V, I_C = 0
Input Off Voltage	$V_{I(off)}$	-0.3	—	—	V	V_{CC} = -5V, I_O = -100µA
On Characteristics (Note 6)						
Input-On Voltage	$V_{I(on)}$	—	—	-1.4	V	V_O = -0.3V, I_O = I_C = 1mA
Input Current	I_I	—	—	-0.88	mA	V_I = -5V
DC Current Gain	h_{FE}	80	—	—	—	V_{CE} = -5V, I_C = -5mA
Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	—	—	-0.25	V	I_C = -50mA, I_B = -2.5mA
Output On Voltage (Same as $V_{CE(sat)}$)	$V_{O(on)}$	—	-0.1	-0.3	V	I_I = -0.25mA, I_O = -5mA
Input Resistance	R1	7	10	13	kΩ	—
Resistance Ratio	(R2/R1)	3.7	4.7	5.7	—	—
Small Signal Characteristics						
Current Gain-Bandwidth Product	f_T	—	250	—	MHz	V_{CE} = -10V, I_E = -5mA, f = 100 MHz

Notes: 5. For the device mounted on minimum recommended pad layout 1oz copper that is on a single-sided 1.6mm FR4 PCB; device is measured under still air conditions whilst operating in steady state condition. The entire exposed collector pad is attached to the heatsink.
6. Measured under pulsed conditions. Pulse width ≤ 300µs. Duty cycle ≤ 2%.

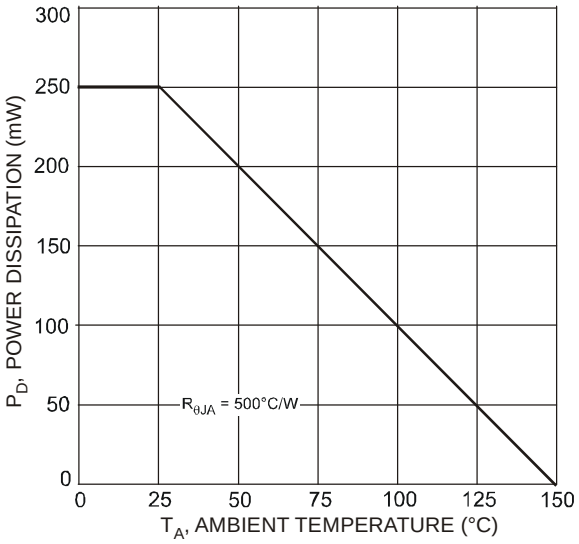


Fig. 1 Power Dissipation vs. Ambient Temperature (Note 4)

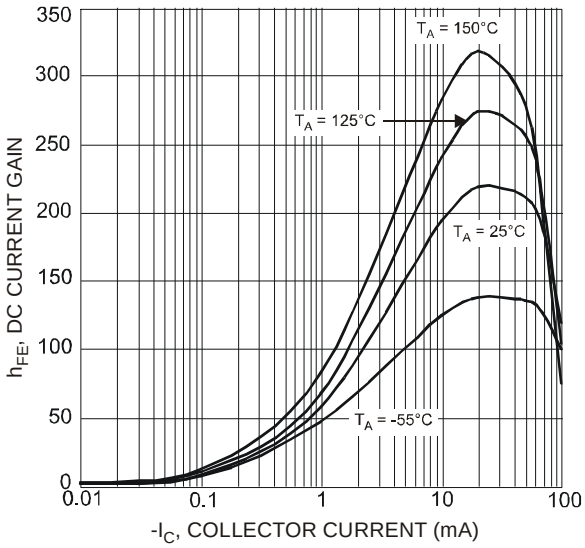


Fig. 2 Typical DC Current Gain vs. Collector Current

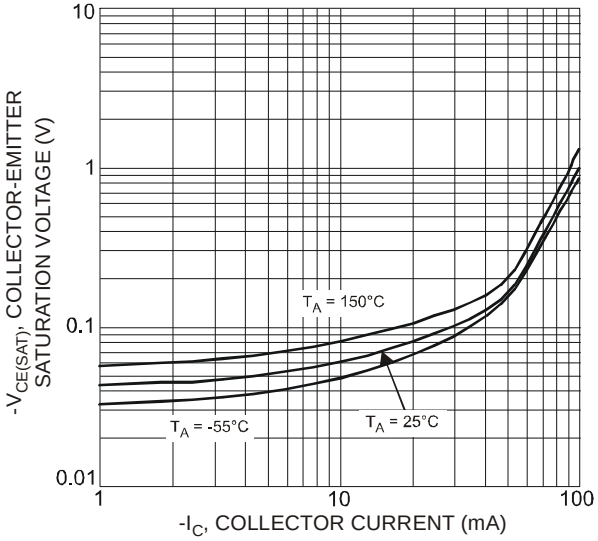


Fig. 3 Typical Collector-Emitter Saturation Voltage vs. Collector Current

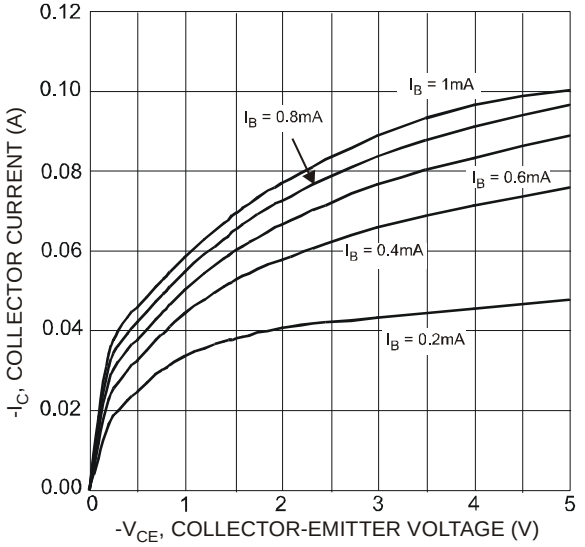


Fig. 4 Typical Collector Current vs. Collector-Emitter Voltage

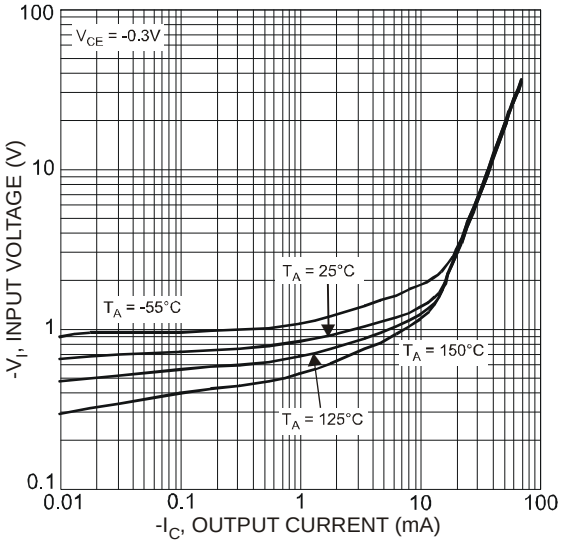


Fig. 5 Typical Input Voltage vs. Output Current (On Characteristics)

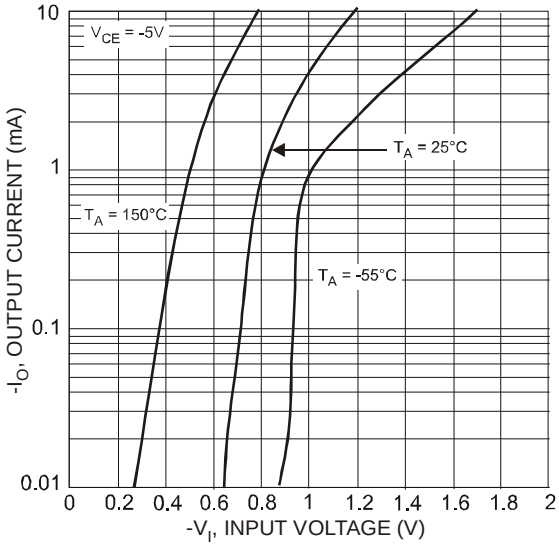
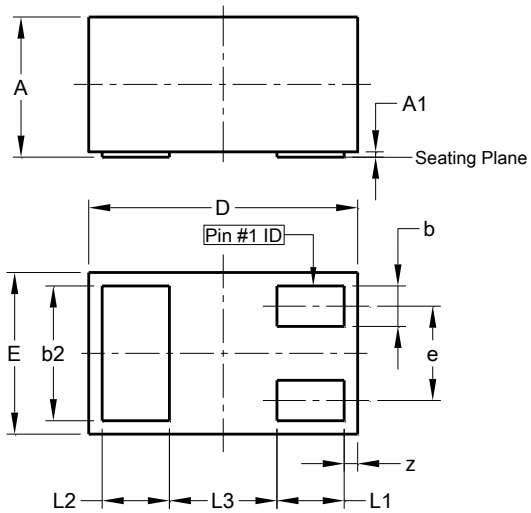


Fig. 6 Typical Output Current vs. Input Voltage (Off Characteristics)

Package Outline Dimensions

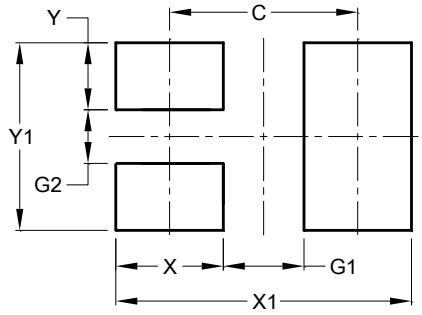
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



X1-DFN1006-3			
Dim	**Min**	**Max**	**Typ**
A	0.47	0.53	0.50
A1	0.00	0.05	0.03
b	0.10	0.20	0.15
b2	0.45	0.55	0.50
D	0.95	1.075	1.00
E	0.55	0.675	0.60
e	-	-	0.35
L1	0.20	0.30	0.25
L2	0.20	0.30	0.25
L3	-	-	0.40
z	0.02	0.08	0.05
All Dimensions in mm			

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
C	0.70
G1	0.30
G2	0.20
X	0.40
X1	1.10
Y	0.25
Y1	0.70

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